

OLED DISPLAY MODULE

Product Specification

CUSTOMER	Standard	
PRODUCT NUMBER	DD-160128FC-1A	
CUSTOMER APPROVAL		Date

INTERNAL APPROVALS			
Product Mgr Doc. Control Electr. Eng			
Bruno Anthony Recaldini Perkins		Bazile	
		Peter	

\square Approva	I for Spec	ification	only
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[☐] Approval for Specification and Sample



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REVISION RECORD

Rev.	Date	Page	Chapt.	Comment	ECR no.
A	10-Jul-06			First Issue	
		4	1	Update panel size	
		6	2.2	Update mechanical drawing	
		9	3.3	Update pin definition	
В	09-Feb-10	11	3.4	Update block diagram	
	12	3.5	Update AC characteristics		
	19	5.2	Update power up sequence		
	20	5.4	Update initialization		
С	28 Nov 12	29	10	Add chapter 10 supported accessories	
28 NOV 12				Change Densitron logo at Header	

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1 MAIN FEATURES

ITEM	CONTENTS	
Display Format	160 (RGB) x 128 Dots	
Overall Dimensions Glass 35.8 x 30.8 x 1.6 mm		
Colour	262,144 Colour	
Active Area	28.78 x 23.024 mm	
Viewing Area	30.78 x 25.02 mm	
Display Mode Passive Matrix (1.45")		
Driving Method	1/128 duty	
Driver IC	SEPS525F	
Operating temperature	-20 ~ +70	
Storage temperature	-30 ~ +80	

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2 MECHANICAL SPECIFICATION

2.1 MECHANICAL CHARACTERISTICS

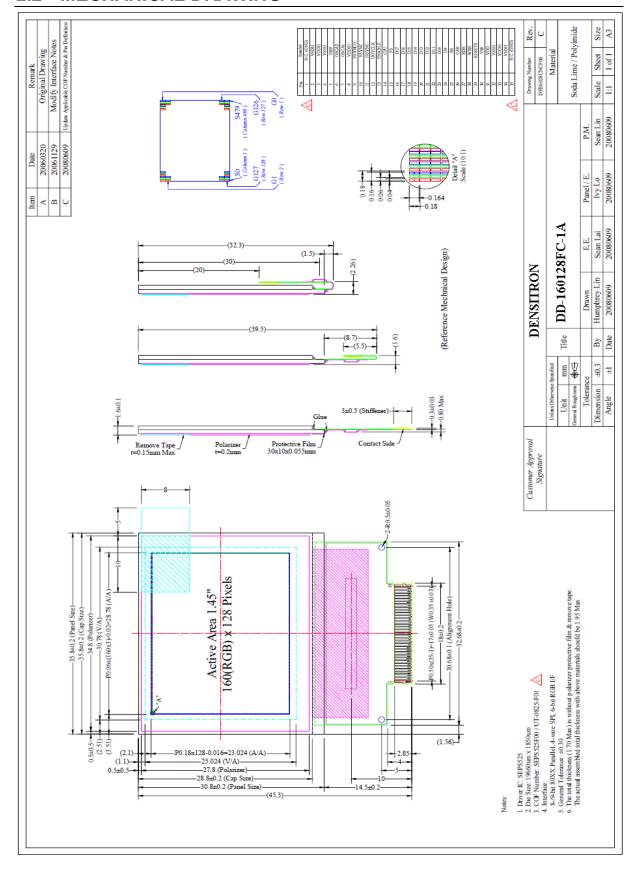
ITEM	CHARACTERISTIC	UNIT
Display Format	160 (RGB) x 128	Dots
Overall Dimensions	35.80 x 30.80 x 1.6	mm
Viewing Area	30.78 x 25.02	mm
Active Area	28.78 x 23.024	mm
Dot Size	0.04 x 0.164	mm
Dot Pitch	0.06 x 0.18	mm
Weight	3.6	g
IC Controller/Driver	SEPS525F (COF)	

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2.2 MECHANICAL DRAWING



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3 ELECTRICAL SPECIFICATION

3.1 ABSOLUTE MAXIMUM RATINGS

VSS = 0 V, Ta = 25 °C

Item	Symbol	Min	Max	Unit	Note	
Power Supply Voltage	V_{DD}	-0.3	4	V		
Supply Voltage for I/O Pins	$V_{ m DDIO}$	-0.3	4	V	Note 1, 2	
OLED Power Supply	$V_{ m DDH}$	-0.3	16	V		
Operating Temperature	Тор	-30	70	°C		
Storage Temperature	Tst	-40	80	°C		
Static Electricity	Be sure that you are grounded when handling displays.					

Note 1: All the above voltages are on the basis of "VSS=0V".

Note 2: When this module is used beyond the above absolute maximum ratings, permanent damage to the module may occur. Also for normal operations it's desirable to use this module under the conditions according to Section 3.2 "Electrical Characteristics". If this module is used beyond these conditions the module may malfunction and the reliability could deteriorate.



3.2 ELECTRICAL CHARACTERISTICS

Characteristics	Symbol	Conditions	Min	Тур	Max	Unit
Supply Voltage	V_{DD}		2.6	2.8	3.3	V
Supply Voltage x I/O pins	V_{DDIO}		1.6	2.8	3.3	V
Supply Voltage for Display	V_{DDH}	Note 3	12.5	13	13.5	V
High Level Input	V_{IH}		$0.8 \mathrm{xV}_\mathrm{DD}$	-	V_{DD}	V
Low Level Input	$V_{\rm IL}$		0	-	0.4	V
High Level Output	V_{OH}	$I_{OH} = -0.4 \text{mA}$ $I_{OH} = -0.4 \text{mA}$	V _{DD} -0.4	-	-	V
Low Level Output	V _{OL}	$I_{OL} = -0.1 \text{mA}$ $I_{OL} = -0.1 \text{mA}$	-	-	0.4	V
VDD Current	Idd	Note 1 Note 2	-	2.5	3.5	mA
Vcc Current	Lag	Note 1	-	16	19	mA
VCC Current	Icc	Note 2	-	27	32	mA

Note 1 $V_{DD} = 2.8V$, $V_{CC} = 13V$, Software initial setting follow chapter 5.4, 50% Display area turned on.

Note 2 $V_{DD} = 2.8V$, $V_{CC} = 13V$, Software initial setting follow chapter 5.4, 100% Display area turned on

Note 3 Brightness (Lbr) and driver supply voltage (VDDH) could be changed to customer request.

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3.3 INTERFACE PIN ASSIGNMENT

No.	Symbol	I/O	Function	
1	N.C. (GND)	-	Reserved Pin (Supporting Pin). The supporting pin can reduce the influence from stress on the function pins. This pin must be connected to external ground.	
2	VSDH	Р	Ground of OEL Panel This is a ground pin for analogue circuits. It must be connected to external ground VSDH: Segment (Data Drive)	
3	VDDH	P	Power Supply for OEL Panel This is the most positive supply pin of the chip. This must be connected to external source.	
4.	VSSH	Р	Ground of OEL Panel This is a ground pin for analogue circuits. It must be connected to external ground VSSH: Common (Scan Drive)	
5	IREF	I/O	Current Reference for Brightness Adjustment This pin is segment (data) current reference pin. A 68ΚΩ resistor should be connected between this pin and VSS.	
6	OSCA2	О	Fine Adjustment for Oscillation The frequency is controlled by external $10K\Omega$ resistor between	
7	OSCA1	I	OSCA1 and OSCA2. The oscillator signal is used for system clock generation. When the external clock mode is selected, OSCA1 is used external clock input	
8	VDDIO	P	Power Supply for I/O Pin This pin is a voltage supply pin. It should be match with MCU interface voltage level. It must always be equal or lower than VDD.	
9	VSYNCO	О	Vertical Synchronization Triggering Signal	
10	VSYNC	I	Vertical Synchronization Input	
11	HSYNC	I	Horizontal Synchronization Input	
12	COTCLK	I	Dot Clock Input	
13	ENABLE	I	Video Enable Input	
14	CPU	I	Select the CPU type Low: 80-Series MCU High: 68-Series MCU	
15	PS	I	Select Parallel/Serial type Low: Serial Interface High: Parallel Interface	
16	D17		Host Data Input/Output Bus	
17	D16		These pins are 9-bit bi-directional data bus to be connected to	
18	D15	I/O	the microprocessor's data bus.	
19	D14		PS Description	
20	D13			

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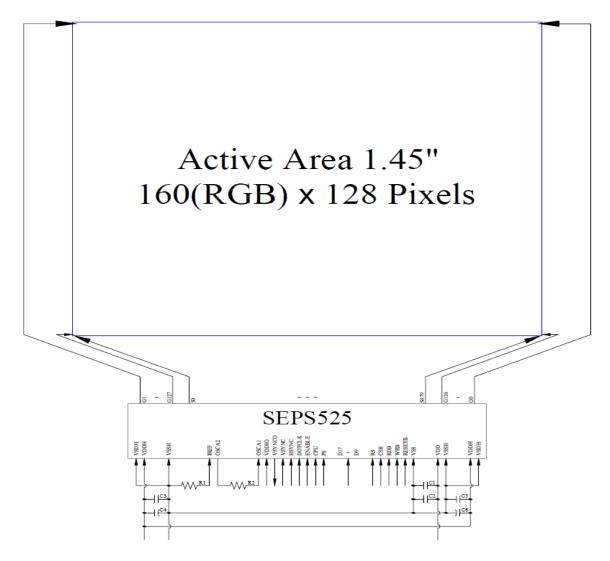


21	D12		8-bit Bus: D17 to D10		
22	D11		9-bit Bus: D17 to D9 D[17] SCL: Synchronous Clock Input		
23	D10		0 D[16] SDI: Serial Data Input		
24	D9		D[15] SDO: Serial Data Output		
25	RS	I	Data/Command Control Low: Command High: Parameter/data		
26	CSB	Ι	Chip Select Low: SEPS525 is selected and can be accessed High: SEPS525 is not selected and cannot be accessed		
27	RDB	Ι	Read or Read/Write Enable 80-System bus interface: Read strobe signal (Active Low) 68-System bus interface: Bus enable strobe (Active High) When serial mode, fix this to VDD or VSS Level		
28	WRB	Ι	Write or Read/Write Select 80-System bus interface: Write strobe signal(active Low) 68-System bus interface: Read (low)/write (high) select. When serial mode, fix this to VDD or VSS Level		
29	RESETB	I	Power Reset for Controller and Driver A reference. When the pin is low, initialization of the chip is executed.		
30	VSS	P	Ground of Logic Circuit This is a ground pin. It also acts as a reference for the logic pins. It must be connected to external ground		
31	VDD	P	Power Supply for Core Logic Circuit This is a voltage supply pin. It must be connected to external source.		
32	VSSH	Р	Ground of OEL Panel This is a ground pin for analogue circuits. It must be connected to external ground VSSH: Common (Scan Drive)		
33	VDDH	Р	Power Supply for OEL Panel This is the most positive supply pin of the chip. This must be connected to external source.		
34	VSDH	P	Ground of OEL Panel This is a ground pin for analogue circuits. It must be connected to external ground VSDH: Segment (Data Drive)		
35	N.C. (GND)		Reserved Pin (Supporting Pin). The supporting pin can reduce the influence from stress on the function pins. This pin must be connected to external ground.		

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3.4 BLOCK DIAGRAM



MCU Interface Selection: PS and CPU

Pins connected to MCU interface: D17~D9, RS, CSB, RDB, WRB, and RESETB. Pins connected to RGB interface: D17~D9, VSYNC, HSYNC, DOTCLK, and ENABLE

C1, C3, C5: 0.1 µF C2: 4.7 µF

C4, C6: 4.7 Mf /25 V Tantalum Capacitor

R1: $68 \text{ k}\Omega$ R2: $10 \text{ k}\Omega$

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3.5 TIMING CHARACTERISTICS

3.5.1 AC CHARACTERISTICS

3.5.1.1 6800-Series MPU Parallel Interface Timing Characteristics

VDD = 2.8V, Ta = 25°C

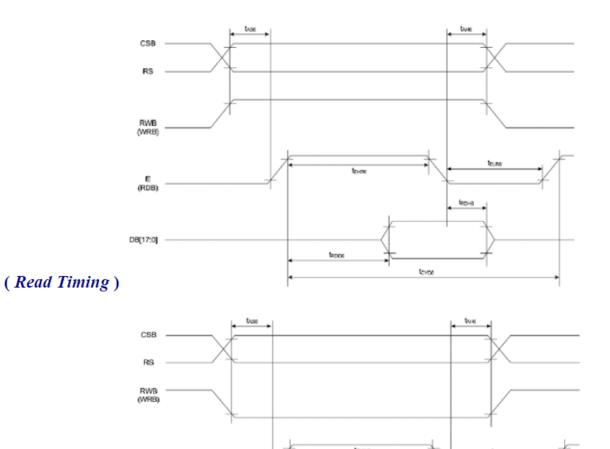
Characteristics	Symbol	Min	Max	Unit	Port
Write Timing					
Address hold timing	tAH6	10		nS	CSB
Address setup timing	tAS6	5	•	113	RS
System cycle timing Write	tCYC6	200			
"L" pulse width Write	tELW6	45] -	nS	Е
"H" pulse width	tEHW6	45]		
Data setup timing	tDS6	40		nS	DB[17:0]
Data hold timing	tDH6	10] -	113	נט./וושם
Read Timing					
Address hold timing	tAH6	10		nS	CSB
Address setup timing	tAS6	5] -	113	RS
System cycle timing Write	tCYC6	200			
"L" pulse width Write	tELW6	90] -	nS	Е
"H" pulse width	tEHW6	90			
Data setup timing (CL= 15pF)	tDS6	0	70	nS	DB[17:0]
Data hold timing (CL= 15pF)	tDH6	U	70	113	[17.0]

• All the timing should be based on 10% and 90% of V_{DD} .

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(Write Timing)

DB[17:0]

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3.5.1.2 8080-Series MPU Parallel Interface Timing Characteristics

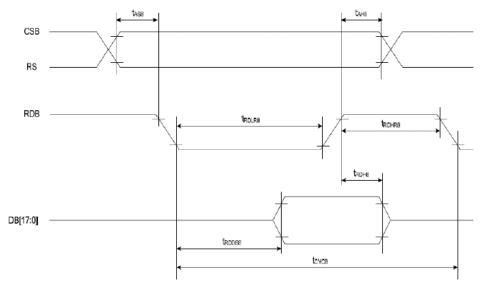
Characteristics	Symbol	Min	Max	Unit	Port
Write Timing					
Address hold timing	tAH8	5		nS	CSB
Address setup timing	tAS8	5	-	1115	RS
System cycle timing Write	tCYC8	100			
"L" pulse width Write	tWRLW8	45	-	nS	WRB
"H" pulse width	tWRW8	45			
Data setup timing	tDS8	30		- C	DD[17.0]
Data hold timing	tDH6	10	-	nS	DB[17:0]
Read Timing					
Address hold timing	tAH8	5		nS	CSB
Address setup timing	tAS8	5	-	119	RS
System cycle timing Write	tCYC8	200			
"L" pulse width Write	tRDLR8	90	-	nS	RDB
"H" pulse width	tRDHR8	90			
Data setup timing (CL=	tDS8	0	60	nS	DB[17:0]
Data hold timing (CL= 15pF)	tDH8	U	00	119	[۱/.۷] [מע

^{*} All the timing should be based on 10% and 90% of V_{DD}

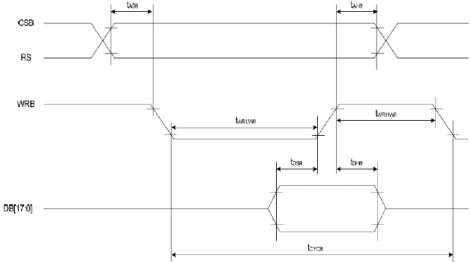
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(Read Timing)



(Write Timing)

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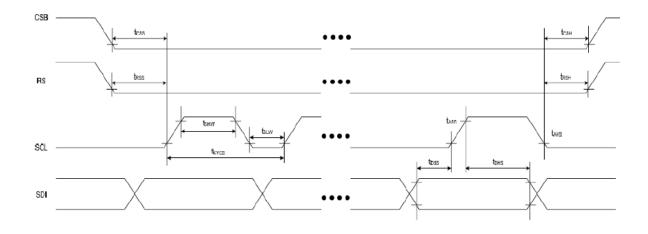


3.5.1.3 Serial Interface Timing Characteristics

ITEM	SYMBOL	MIN	MAX	UNIT	PORT
Serial clock cycle SCL	tCYCS	60			
"H" pulse width SCL	tSHW	25	-	nS	SCL
"L" pulse width	tSLW	25			
Data setup timing Data	tDSS	25		nS	SDI
Hold timing	tDHS	25	-	119	SDI
CSB-SCL timing	tCSS	25		C	CCD
CSB-hold timing	tCSH	25	-	nS	CSB
RS-SCL Timing	tRSS	25	-	ns	
RS-Hold Timing	tRSH	25	-	ns	RS

^{*} All the timing should be based on 10% and 90% of V_{DD}

Serial Interface Timing



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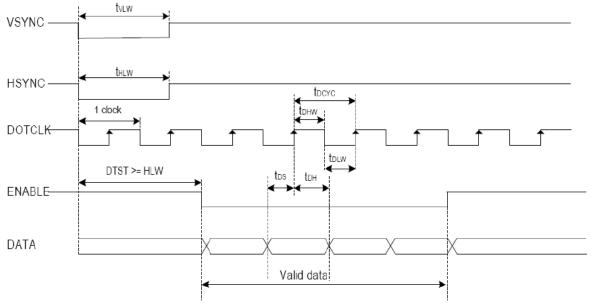
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3.5.1.4 RGB Interface Timing Characteristics

Symbol	Item	Min	Max	Unit	Port
tDCYC	Dot Clock Cycle	100	-	ns	
tDLW	Dot "L" Pulse Width	50	-	ns	DOTCLK
tDHW	Dot "H" Pulse Width	50	-	ns	
tDS	Data Setup Timing	5		ns	D[17,12]
tDH	Data Hold Timing	5		ns	D[17:12]
tVLW	Vsync Pulse Width	1	-	DOTCLK	VSYNC
tHLW	Hsync Pulse Width	1	-	DOTCLK	HSYNC

* All the timing should be based on 10% and 90% of V_{DD}



DTST: Setup Time for Data Transmission

* VSYNC, HSYNC, ENABLE, and D[17:12] should be transmitted by 3 clocks for one pixel (RGB).

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4 OPTICAL SPECIFICATION

4.1 OPTICAL CHARACTERISTICS

Characteristics	Symbol	Condition	Min	Тур	Max	Unit
Brightness(White)	L_{br}	Display Average Note 1	75	100	-	cd/m ²
CIE (WILL)	(X)		0.26	0.30	0.34	
C.I.E.(White)	(Y)		0.29	0.33	0.37	-
CIE (Pad)	(X)		0.60	0.64	0.68	
C.I.E.(Red)	(Y)		0.30	0.34	0.38	-
CIE (Graan)	(X)		0.27	0.31	0.35	
C.I.E.(Green)	(Y)		0.58	0.62	0.66	-
C.I.E.(Blue)	(X)		0.10	0.14	0.18	
C.I.E.(Blue)	(Y)		0.12	0.16	0.20	-
Dark Room Contrast	CR		-	>2000:1	-	-
Viewing Angle			>160	-	-	degree

Optical measurement, follow the software initial setting on chapter 5.4

Note 1: Brightness (Lbr) and driver supply voltage (VCC) could be changed to customer request.

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5 FUNCTIONAL SPECIFICATION

5.1 COMMANDS

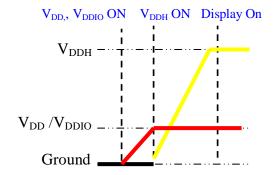
Please refer to the Technical Manual for the SEPS525F

5.2 POWER UP/DOWN SEQUENCE

To protect panel and extend the panel lifetime, the driver IC power up/down routine should include a delay period between high voltage and low voltage power sources during turn on/off. It gives the panel enough time to complete the action of charge and discharge before/after the operation.

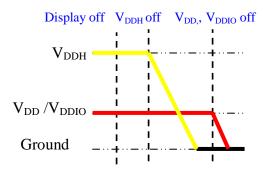
5.2.1 POWER UP SEQUENCE

- 1. Power up $V_{DD \&} V_{DD IO}$
- 2. Send Display off command
- 3. Initialization
- 4. Clear Screen
- 5. Power up V_{DDH}
- 6. Delay 100ms (When V_{DDH} is stable)
- 7. Send Display on command



5.2.2 POWER DOWN SEQUENCE

- 1. Send Display off command
- 2. Power down V_{DDH}
- 3. Delay 100ms (When V_{DDH} reach 0 and panel is completely discharges)
- 4. Power down V_{DD} & V_{DDIO}



5.3 RESET CIRCUIT

When RESETB input is low, the chip is initialized with the following status:

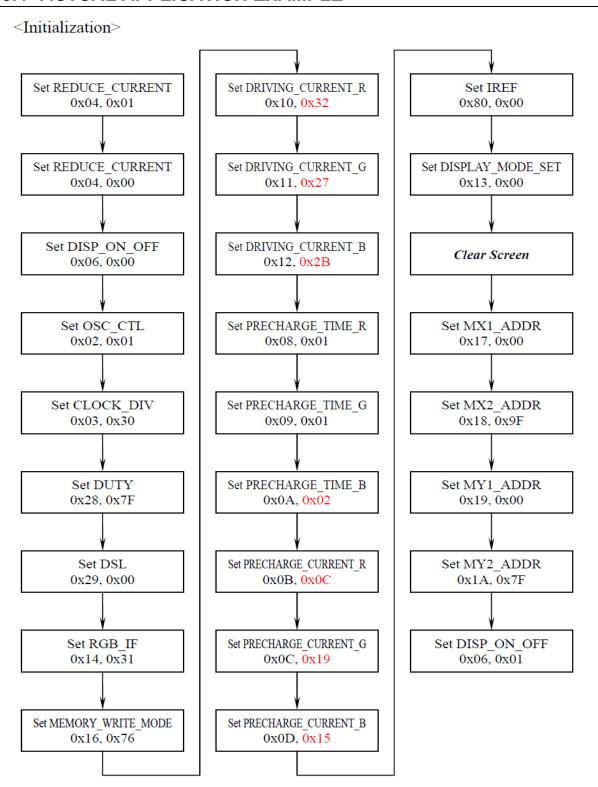
- 1. Frame frequency: 90Hz
- 2. OSC: internal OSC ON
- 3. DDRAM write horizontal address: MX1 = 00h, MX2 = 9Fh
- 4. DDRAM write vertical address: MY1 = 00h, MY2 = 7Fh
- 5. Display data RAM write: HC = 1, VC = 1, HV = 0
- 6. RGB data swap: OFF
- 7. Row scan shift direction: G0, G1, ..., G126, G127
- 8. Column data shift direction: S0, S1, ..., S478, S479
- 9. Display ON/OFF: OFF
- 10. Panel display size: FX1 = 00h, FX2 = 9Fh, FY1 = 00h, FY2 = 7Fh
- 11. Display data RAM read column/row address: FAC = 00h, FAR = 00h
- 12. Pre-charge time(R/G/B): 0 clock
- 13. Pre-charge current(R/G/B): 0 uA
- 14. Driving current(R/G/B): 0 uA

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5.4 ACTUAL APPLICATION EXAMPLE



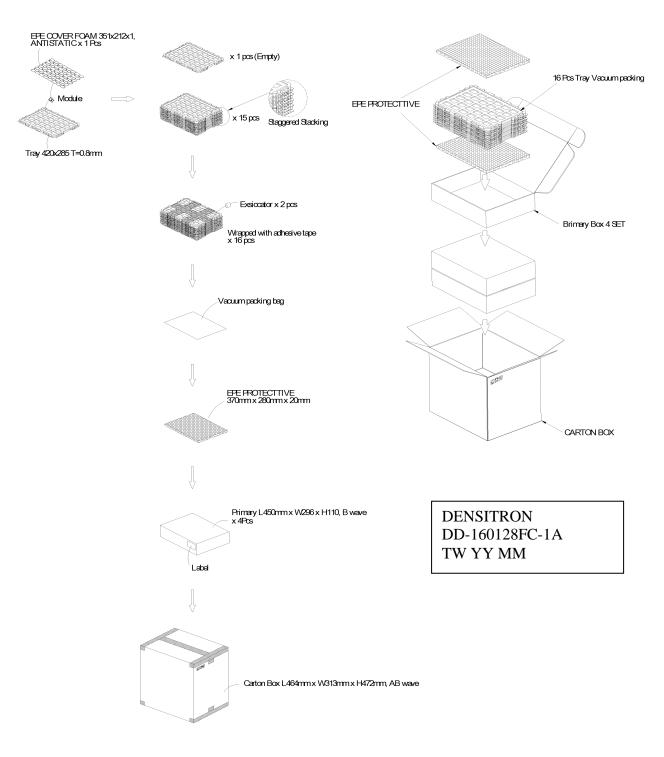
If the noise is accidentally occurred at the displaying window during the operation, please reset the display in order to recover the display function.

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6 PACKAGING AND LABELLING SPECIFICATION

6.1 LABELLING & MARKING



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7 QUALITY ASSURANCE SPECIFICATION

7.1 CONFORMITY

The performance, function and reliability of the shipped products conform to the Product Specification.

7.2 DELIVERY ASSURANCE

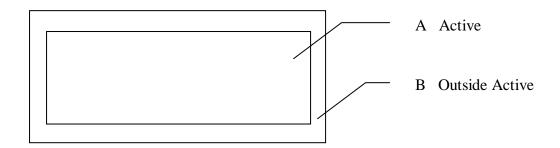
7.2.1 DELIVERY INSPECTION STANDARDS

MIL-STD-105E, general inspection level II, single sampling level; IPC-AA610 rev. C, class 2 electronic assemblies standard

The quality assurance levels are shown below:

Class	AQL (%)
Critical defect	0.5%
Major defect	1.0%
Minor defect	1.5%
TOTAL	2.0%

7.2.2 Zone definition



7.2.3 Visual inspection

Test and measurement to be conducted under following conditions:

Temperature: 23 ± 5 °C

Humidity: $55\pm15\%$ RH

Fluorescent lamp: 30 W

Distance between the Panel & Eyes of the Inspector: $\geqq 30$ cm

Distance between the Panel & the lamp: ≥50cm

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7.2.4 Standard of appearance inspection

Units: mm

Units: m							
Class	Item		Criteria				
Minor	Packing &	Outside & in	Outside & inside package Presence of product no., lot no., quantity				
Critical	Label		Product must not be mixed with others and quantity must not be different from				
		that indicated					
Major	Dimension	Product dime	Product dimensions must be according to specification and drawing				
Major	Electrical	Product elect	Product electrical characteristics must be according to specification				
Critical	OLED Display	Missing lines	s, short circui	its or wrong patter	ns on OLED disp	lay are not	
Minor	Black spot, white spot,	Round type: $\emptyset = (X+Y)/2$	_	ving drawing			
	dust			A	cceptable quantity	/	
				Size	Zone A	Zone B	
		•	<u>-</u>	Ø<0.1	Any number		
			Y	0.1<Ø<0.2	3	A	
		→ - + 1		0.2<Ø<0.25	1	Any number	
		X		0.25<Ø	0		
		Line type: as	s per followin	Acceptal	ole quantity		
		_ w	Length	Width	Zone A	Zone B	
		~ <i>"</i> /~ [W≤0.05	Any number		
		/	L≤2.0	W≤0.1	3	Any number	
			L>2.0		0		
			Total accept	table quantity: 3			
Minor	Polariser scratch	_	rotective film olariser: same	n is permitted e as No. 1			
Minor	Polariser	$\emptyset = (X+Y)/2$					
	bubble			A	cceptable quantity	1	
				Size	Zone A	Zone B	
		•	<u>. </u>	Ø<0.5	Any number	A n.v. m.v1	
			Y	Ø>0.5	0	Any number	
		X					

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Class	Item	Criteri	a	
Minor	Segment deformation	1b. Pin hole on dot matrix display	Acceptable Size $a,b<0.1$ $(a+b)/2\leq0.1$ $0.5<\varnothing<1.0$ Total acceptable	Any number Any number 3
		2. Segments / dots with different width	Accep a≥b a <b< td=""><td>table a/b≤4/3 a/b>4/3</td></b<>	table a/b≤4/3 a/b>4/3
		3. Alignment layer defect $\emptyset = (a+b)/2$	Acceptable Size $\emptyset \le 0.4$ $0.4 < \emptyset \le 1.0$ $1.0 < \emptyset \le 1.5$ $1.5 < \emptyset \le 2.0$ Total acceptable	Any number 5 3 2
Minor	Panel Chipping	$X \le 1/6$ Panel length $Y \le 1$ $Z \le T$	T	Z
Minor	Panel Cracking	Cracks not allowed		
Minor	Cupper exposed (pin or film)	Not allowed if visible by eye inspection		
Minor	Film or Trace Damage	Not allowed if affect electrical function		

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Class	Item		Crit	teria	
Minor	Contact Lead Twist	Not allowed		D. TVISTED LEAD	
Minor	Contact Lead Broken	Not allowed		A. BROKEN LEAD	
Minor	Contact Lead Bent	Not allowed if bent lead causes short circuit			
		Not allowed if bent extends horizontall more than 50% of its width	/		
Minor	Colour uniformity	Level of sample for	r approval set as lim	it sample	
Major	PCB _	No unmelted solder	r paste should be pre	esent on PCB	
Critical				ections, or oxidation	are not allowed
Minor			er balls on PCB are a		
Critical		Short circuits on co	omponents are not al		
Minor	Tray particles			Size Ø<0.2	Quantity Any number
	particles		On tray	Ø<0.2 Ø>0.25	Any number 4
			0 1: 1	Ø≥0.25	2
			On display	L = 3	1

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7.3 DEALING WITH CUSTOMER COMPLAINTS

7.3.1 Non-conforming analysis

Purchaser should supply Densitron with detailed data of non-conforming sample. After accepting it, Densitron should complete the analysis in two weeks from receiving the sample.

If the analysis cannot be completed on time, Densitron must inform the purchaser.

7.3.2 Handling of non-conforming displays

If any non-conforming displays are found during customer acceptance inspection which Densitron is clearly responsible for, return them to Densitron.

Both Densitron and customer should analyse the reason and discuss the handling of non-conforming displays when the reason is not clear.

Equally, both sides should discuss and come to agreement for issues pertaining to modification of Densitron quality assurance standard.

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8 RELIABILITY SPECIFICATION

8.1 RELIABILITY TESTS

Test Item	Test Condition	Evaluation and assessment
High Temperature Operation	70°C±2, 240 hours	No abnormalities in function and appearance
Low Temperature Operation	-30°C±2, 240 hours	No abnormalities in function and appearance
High Temperature Storage	80°C±2, 240 hours	No abnormalities in function and appearance
Low Temperature Storage	-40°C±2, 240 hours	No abnormalities in function and appearance
High Temperature & High Humidity Storage(Operation)	60°C±2, 90%RH, 120 hours	No abnormalities in function and appearance
Thermal Shock	24 cycle of -40°C 1 Hour, 85°C 1 Hour	No abnormalities in function and appearance

- The brightness should be greater than 50% of the initial brightness.
- The samples used for above tests do not include polarizer.
- No moisture condensation is observed during tests.

8.1.1 FAILURE CHECK STANDARD

After the completion of the described reliability test, the samples were left at room temperature for 2 hrs prior to conducting the failure teat at 23 ± 5 °C; $55\pm15\%$ RH

8.2 LIFE TIME

Item	Description		
1	Function, performance, appearance, etc. shall be free from remarkable deterioration more than 10,000 hours under 100 CD/m² brightness and storage conditions of room temperature (25 °C), normal humidity (50 RH), and in area not exposed to direct sunlight.		
2	End of lifetime is specified as 50% of initial brightness.		

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9 HANDLING PRECAUTIONS

Safety

If the panel breaks, be careful not to get the organic substance in your mouth or in your eyes. If the organic substance touches your skin or clothes, wash it off immediately using soap and plenty of water.

Mounting and Design

Place a transparent plate (e.g. acrylic, polycarbonate or glass) on the display surface to protect the display from external pressure. Leave a small gap between the transparent plate and the display surface.

Design the system so that no input signal is given unless the power supply voltage is applied.

Caution during OLED cleaning

Lightly wipe the display surface with a soft cloth soaked with Isopropyl alcohol, Ethyl alcohol or Trichlorotriflorothane.

Do not wipe the display surface with dry or hard materials that will damage the polariser surface. Do not use aromatic solvents (toluene and xylene), or ketonic solvents (ketone and acetone).

Caution against static charge

As the display uses C-MOS LSI drivers, connect any unused input terminal to V_{DD} or V_{SS} . Do not input any signals before power is turned on.

Also, ground your body, work/assembly table and assembly equipment to protect against static electricity.

Packaging

Displays use OLED elements, and must be treated as such. Avoid strong shock and drop from a height.

To prevent displays from degradation, do not operate or store them exposed directly to sunshine or high temperature/humidity.

Caution during operation

It is indispensable to drive the display within the specified voltage limit since excessive voltage shortens its life.

Other Precautions

When a display module is operated for a long of time with fixed pattern may remain as an after image or slight contrast deviation may occur.

Nonetheless, if the operation is interrupted and left unused for a while, normal state can be restored. Also, there will be no problem in the reliability of the module.

Storage

Store the display in a dark place where the temperature is $25^{\circ}C \pm 10^{\circ}C$ and the humidity below 50% RH.

Store the display in a clean environment, free from dust, organic solvents and corrosive gases. Do not crash, shake or jolt the display (including accessories).

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10 SUPPORTED ACCESSORIES

10.1 DUO KIT

Densitron has developed an easy to use yet powerful development and demonstration tool for driving its range of Passive Matrix OLED displays from the USB port of a PC.

DUO (Densitron USB OLED) kit is hot pluggable and does not require extra cables or power supply to run, allowing users to be up and running in minutes.

The kit consists of an OLED display with transition Board, USB controller card, mini USB cable and a CD with software application and drivers.



Part number: PDK-N-160128FC-1A

10.2 TRANSITION BOARD CARD

A Transition board card is like a daughterboard which is meant to be a circuit board for connections between the baseboards (DUO).

It has connector pins for interfacing between the display and the baseboards.

It also includes the OLED display. **Part number: PDT-N-160128FC-1A**

10.3 CONNECTOR BOARD CARD

A Connector board card is also a daughterboard which is a circuit board for connection between a microprocessor or microcontroller (customer's system).

Part number: EVK-CONNECT-010

10.4 CONNECTOR

Type: ZIF connector

-	Type: Zir connector				
	No. of connections	Pitch (mm)	Manufacturer	Manufacturer part no.	Distributor part no.
	35	0.50	Omron	XF2M-3515-1A	Farnell/1112561 Digikey/ OR727CT-ND

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